128K/256K-bit 2-WIRE SERIAL CMOS EEPROM

General Description

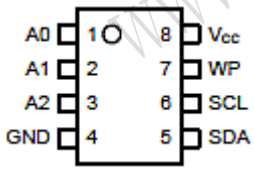
The AX24C128A/AX24C256A provides 131,072/262,144 bits of serial electrically erasable and programmable read-only memory (EEPROM) organized as16,384/32,768 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The AX24C128A/AX24C256A is available in space-saving SOP-8 and TSSOP-8 packages and is accessed via a two-wire serial interface. In addition, the AX24C128A/AX24C256A is available in 1.7V (1.7V to 5.5V) version.

Features

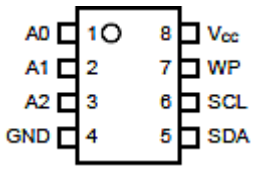
- Wide Voltage Operation
  - V_{CC} = 1.7V to 5.5V
- Operating Ambient Temperature:
  -40°C to +85°C
- Internally Organized:
  - AX24C128A, 16,384 X 8 (128K bits)
  - AX24C256A, 32,768 X 8 (256K bits)
- Two-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 1MHz (5V), 400 KHz (1.7V, 2.5V, 2.7V) Compatibility
- Write Protect Pin for Hardware Data Protection
- 64-byte Page (128K, 256K) Write Modes
- Partial Page Writes Allowed
- Self-timed Write Cycle (5 ms max)
- High-reliability
  - Endurance: 1 Million Write Cycles
  - Data Retention: 100 Years
- SOP-8 and TSSOP-8 packages

Pin Configuration

SOP-8



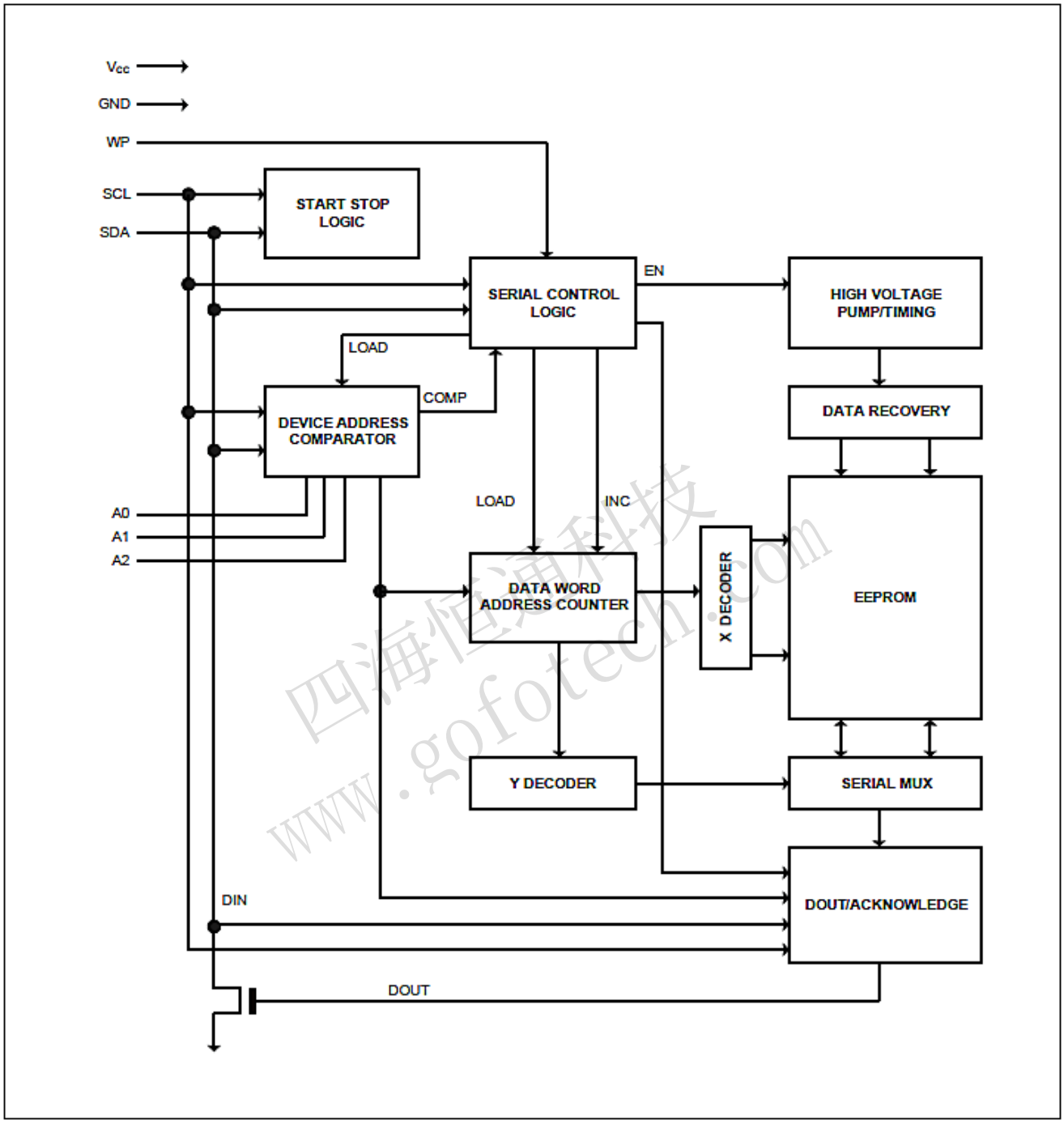
TSSOP-8



Pin Configuration

Pin Name	Type	Functions
A0 - A2	I	Address Inputs
SDA	I/O & Open-drain	Serial Data
SCL	I	Serial Clock Input
WP	I	Write Protect
GND	P	Ground
V_{CC}	P	Power Supply

Block Diagram



Pin Descriptions

DEVICE/PAGE ADDRESSES (A2,A1 and A0): The A2,A1 and A0 pins are device address inputs that are hard wire for the AX24C128A/AX24C256A. Four 128K/256K devices may be addressed on a single bus system (device addressing is discussed in detail under the Device Addressing section).

SERIAL DATA (SDA): The SDA pin is bi-directional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open- collector devices.

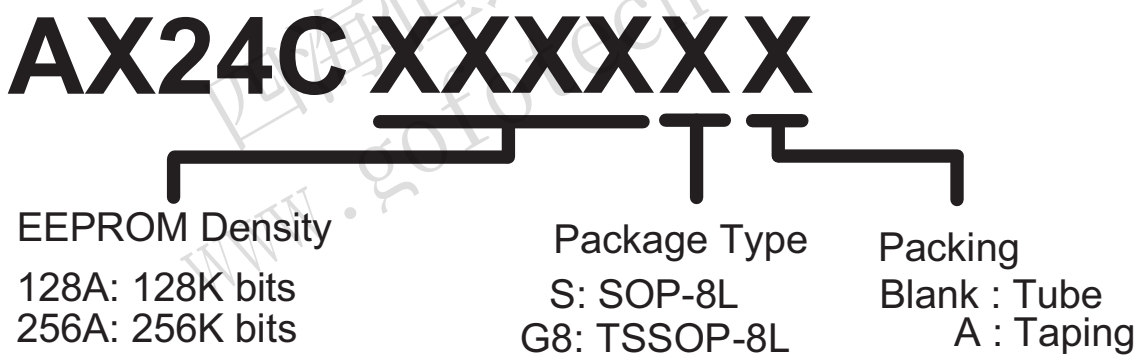
SERIAL CLOCK (SCL): The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.

WRITE PROTECT (WP): The AX24C128A/AX24C256A has a Write Protect pin that provides hardware data protection. The Write Protect pin allows normal read/write operations when connected to ground (GND). When the Write Protect pin is connected to Vcc, the write protection feature is enabled and operates as shown in the following Table.

Write Protect

WP Pin Status	Part of the Array Protected	
	AX24C128A	AX24C256A
At Vcc	Full (128K) Array	Full (256K) Array
At GND	Normal Read / Write Operations	

Ordering/ Marking Information



Available package types

Part Number	SOP-8	TSSOP-8
AX24C128A	V	V
AX24C256A	V	V

Marking Information

Package type	Part Number	Marking	Marking Information
SOP-8	AX24CXXASX	24CXXA XXXXX YYWWT	XX is the memory of production. XXXXX is the last five number of wafer lot number. YYWW is Date Code. T is tracking Code ,T=X
TSSOP-8	AX24CXXAG8X		

Memory Organization

AX24C128A, 128K SERIAL EEPROM: Internally organized with 256 pages of 64 bytes each, the 128K requires an 14-bit data word address for random word addressing.

AX24C256A, 256K SERIAL EEPROM: Internally organized with 512 pages of 64 bytes each, the 256K requires an 15-bit data word address for random word addressing.

Device Operation

CLOCK and DATA TRANSITIONS: The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see to Figure1). Data changes during SCL high periods will indicate a start or stop condition as defined below.

START CONDITION: A high-to-low transition of SDA with SCL high is a start condition which must precede any other command (see to Figure 2).

STOP CONDITION: A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode (see Figure 2).

ACKNOWLEDGE: All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a "0" to acknowledge that it has received each word. This happens during the ninth clock cycle.

STANDBY MODE: The AX24C128A/AX24C256A features a low-power standby mode which is enabled: (a) upon power-up and (b) after the receipt of the STOP bit and the completion of any internal operations

MEMORY RESET: After an interruption in protocol, power loss or system reset, any two-wire part can be reset by following these steps:
1. Clock up to 9 cycles.
2. Look for SDA high in each cycle while SCL is high.
3. Create a start condition.

Figure 1: Data Validity

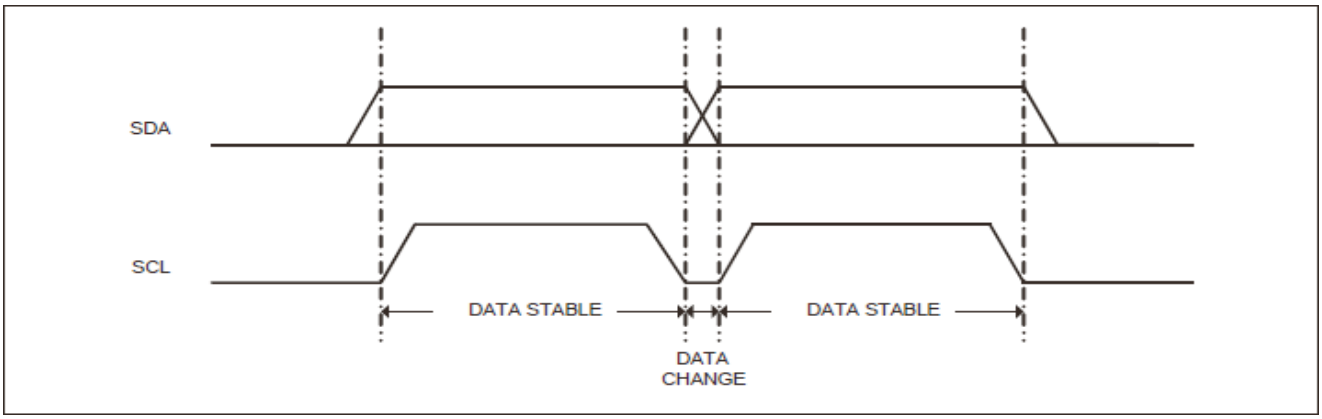


Figure 2: Start and Stop Definition

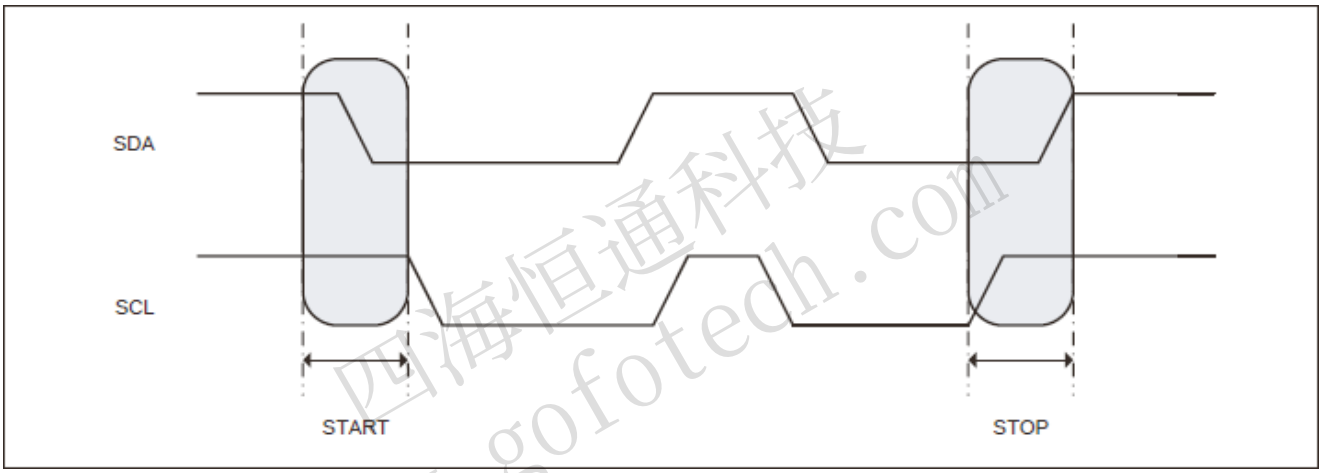
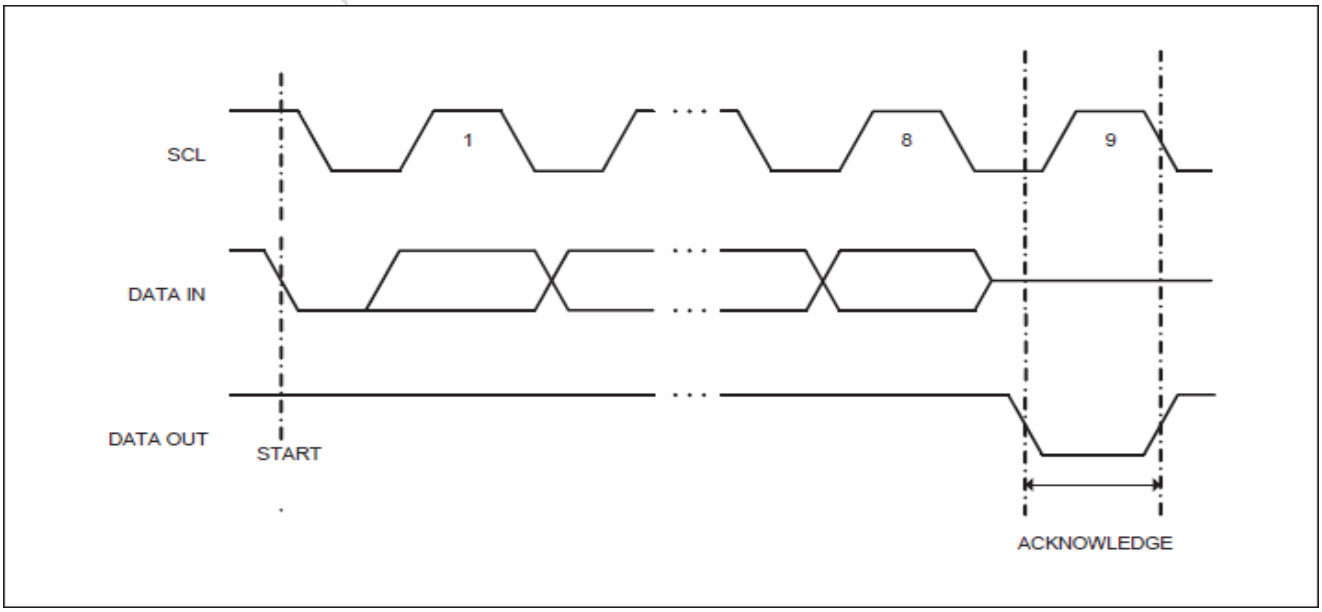


Figure 3: Output Acknowledge



Device Addressing

The 128K/256K EEPROM devices all require an 8-bit device address word following a start condition to enable the chip for a read or write operation (see to Figure 4).
The device address word consists of a mandatory "1", "0" sequence for the first four most significant bits as shown. This is common to all the Serial EEPROM devices.
The 128K/256K EEPROM uses A2, A1 and A0 device address bits to allow as much as four devices on the same bus. These 2 bits must be compared to their conresonding hardwired input pins. The A2, A1 and A0 pins use an internal proprietary circuit that biases them to a logic low condition if the pins are allowed to float.
The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high and a write operation is initiated if this bit is low.
Upon a compare of the device address, the EEPROM will output a "0". If a compare is not made, the chip will return to a standby state.

DATA SECURITY: The AX24C128A /AX24C256A has a hardware data protection scheme that allows the user to write protect the entire memory when the WP pin is at V_{CC}.

Write Operations

BYTE WRITE: A write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a "0" and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a "0" and the ressing device, such as a microcontroller, must terminate the write sequence with a stop condition. At this time the EEPROM enters an internally timed write cycle, tWR, to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (see Figure 5).

PAGE WRITE: The 128K/256K EEPROM is capable of an 64-byte page write.

A page write is initiated the same as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to 63 (128K/256K) more data words. The EEPROM will respond with a "0" after each data word received. The microcontroller must terminate the page write sequence with a stop condition (see Figure 6).
The data word address lower six (128K/256K) bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than 64 data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.

ACKNOWLEDGE POLLING: Once the internally timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a "0", allowing the read or write sequence to continue.

Read Operations

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to "1". There are three read operations: current address read, random address read and sequential read.

CURRENT ADDRESS READ: The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.
Once the device address with the read/write select bit set to "1" is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input "0" but does generate a following stop condition (see Figure 7).

RANDOM READ: A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 8).

SEQUENTIAL READ: Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledge. As long as the EEPROM receives an acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequential read will continue. The sequential read operation is terminated when the microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 9).

Figure 4: Device Address

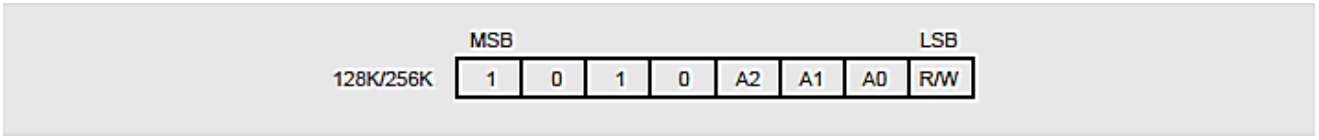


Figure 5: Byte Write

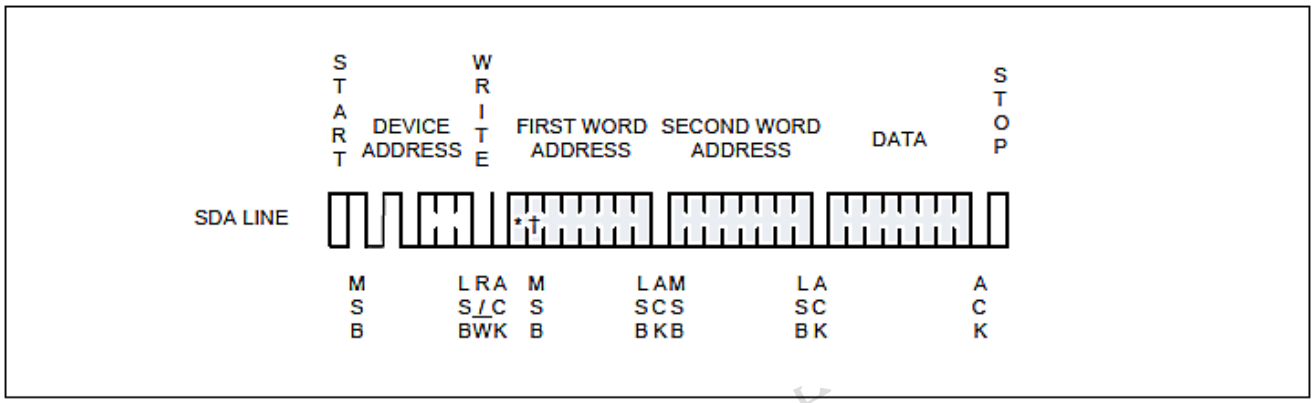
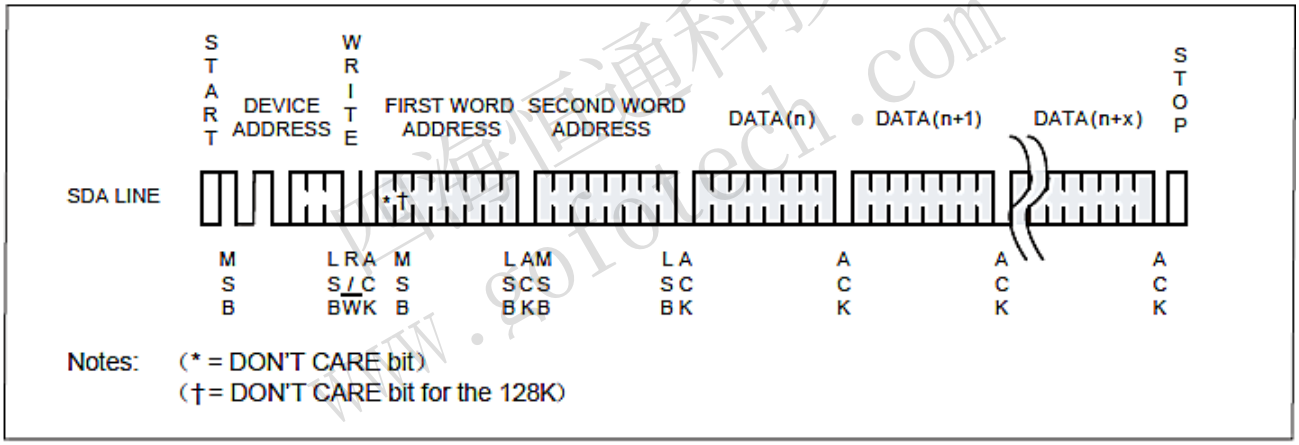


Figure 6: Page Write



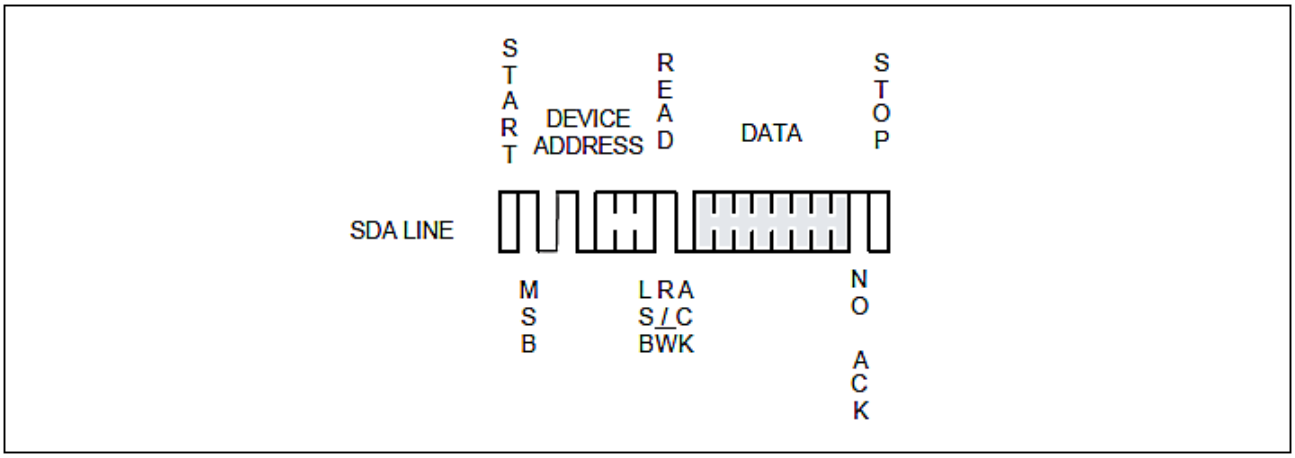


Figure 8: Random Read

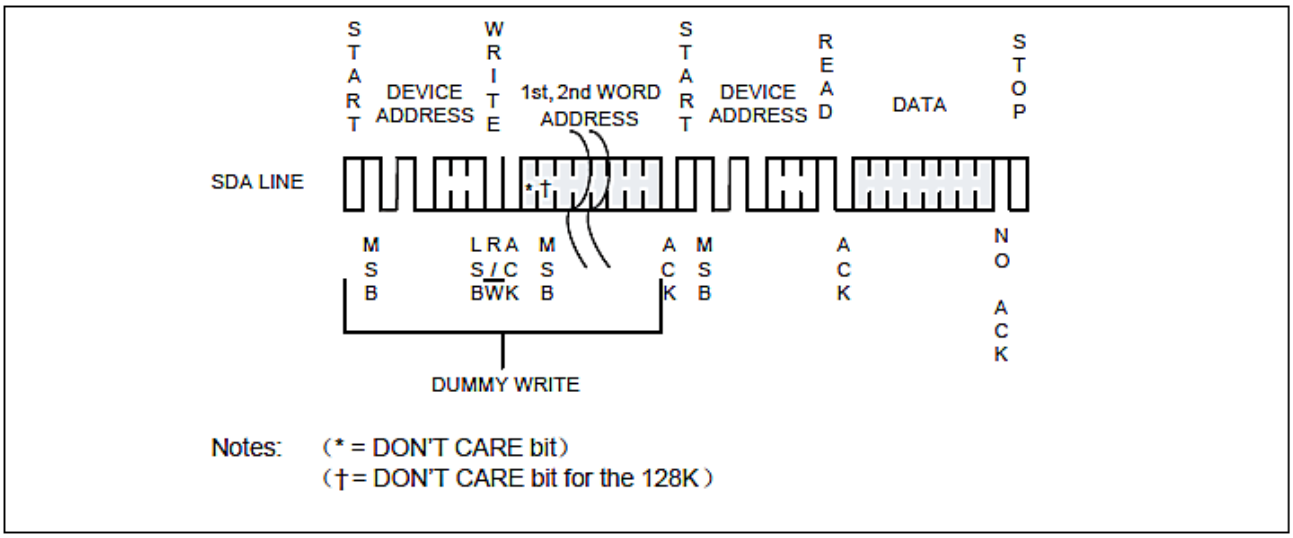
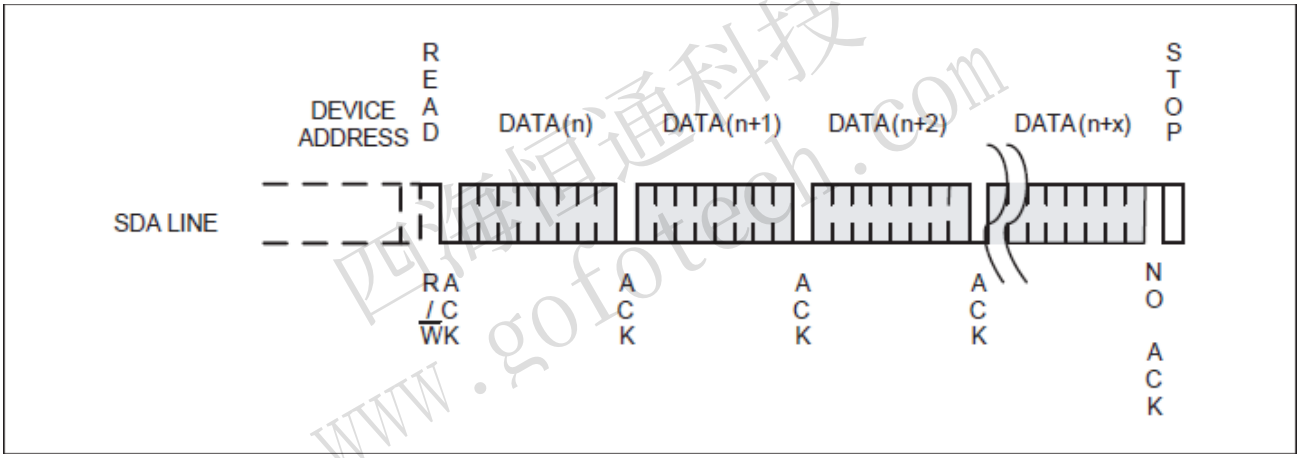


Figure 9: Sequential Read



Electrical Characteristics

Absolute Maximum Stress Ratings

DC Supply Voltage ---------- -0.3V to +6.5V
Input / Output Voltage ---------- GND-0.3V to V_{CC}+0.3V
Operating Ambient Temperature ---------- -40°C to +85°C
Storage Temperature ---------- -65°C to +150°C

Comments

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to this device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied or intended. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

DC Electrical Characteristics

Applicable over recommended operating range from: T_A = -40°C to +85°C , V_{CC} = +1.7V to +5.5V (unless otherwise noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Supply Voltage	V_{CC}	1.7	-	5.5	V	
Supply Current V_{CC} = 5.0V	I_{CC1}	-	0.4	1.0	mA	READ at 400 kHz
Supply Current V_{CC} = 5.0V	I_{CC2}	-	2.0	3.0	mA	WRITE at 400 kHz
Standby Current V_{CC} = 1.7V	I_{SB1}	-	0.6	1.0	µA	V_{IN} = V_{CC} or GND
Standby Current V_{CC} = 2.5V	I_{SB2}	-	1.0	2.0	µA	V_{IN} = V_{CC} or GND
Standby Current V_{CC} = 2.7V	I_{SB3}	-	1.0	2.0	µA	V_{IN} = V_{CC} or GND
Standby Current V_{CC} = 5.0V	I_{SB4}	-	1.0	5.0	µA	V_{IN} = V_{CC} or GND
Input Leakage Current	I_{LI}	-	0.10	3.0	µA	V_{IN} = V_{CC} or GND
Output Leakage Current	I_{LO}	-	0.05	3.0	µA	V_{OUT} = V_{CC} or GND
Input Low Level	V_{IL1}	-0.3	-	V_{CC}x0.3	V	V_{CC} = 1.8V to 5.5V
Input High Level	V_{IH1}	V_{CC}x0.7	-	V_{CC}+0.3	V	V_{CC} = 1.8V to 5.5V
Input Low Level	V_{IL2}	-0.3	-	V_{CC}x0.2	V	V_{CC} = 1.7V
Input High Level	V_{IH2}	V_{CC}x0.7	-	V_{CC}+0.3	V	V_{CC} = 1.7V
Output Low Level V_{CC} =5.0V	V_{OL3}		-	0.4	V	I_{OL} = 3.0 mA
Output Low Level V_{CC} =3.0V	V_{OL2}		-	0.4	V	I_{OL} = 2.1 mA
Output Low Level V_{CC} =1.7V	V_{OL1}		-	0.2	V	I_{OL} = 0.15 mA

Pin Capacitance

Applicable over recommended operating range from T_A = 25°C , f = 1.0 MHz, V_{CC} = +1.7V

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Input/Output Capacitance (SDA)	$C_{I/O}$	-	-	8	pF	$V_{I/O}$ = 0V
Input Capacitance (A0, A1, A2, SCL)	C_{IN}	-	-	6	pF	V_{IN} = 0V

AC Electrical Characteristics

Applicable over recommended operating range from T_A = -40°C to +85°C, V_{CC} = +1.7V to +5.5V, CL = 1 TTL Gate and 100 pF (unless otherwise noted)

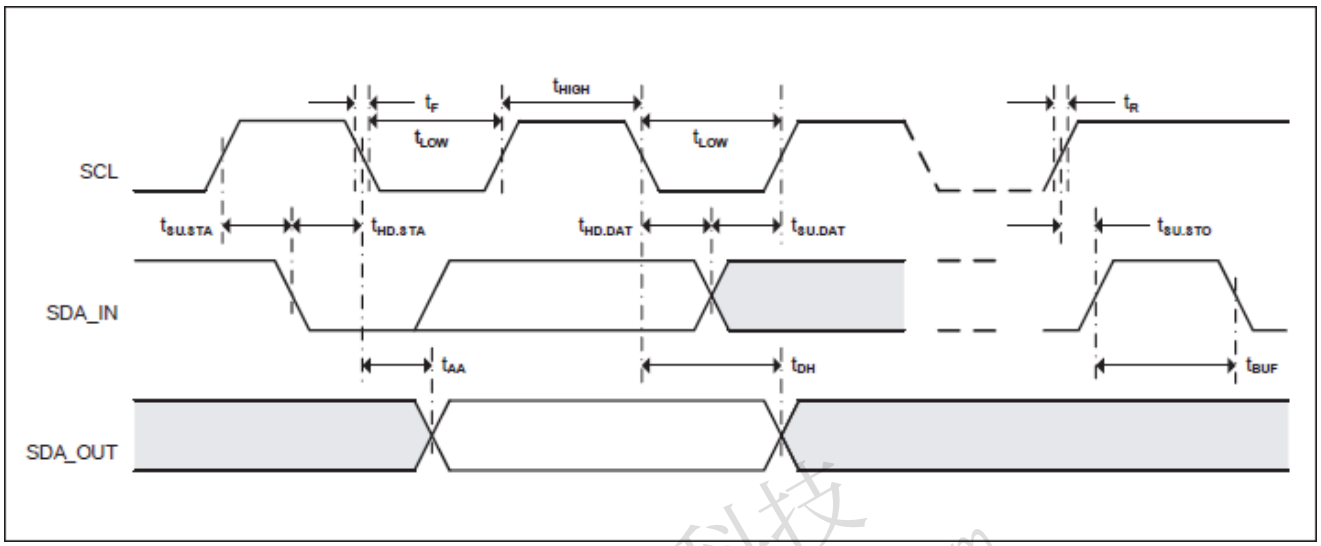
Parameter	Symbol	1.7-volt			5.0-volt			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Clock Frequency, SCL	f_{SCL}	-	-	400	-	-	1000	kHZ
Clock Pulse Width Low	t_{LOW}	1.2	-	-	0.6	-	-	μs
Clock Pulse Width High	t_{HIGH}	0.6	-	-	0.4	-	-	μs
Noise Suppression Time	t_I	-	-	50	-	-	50	ns
Clock Low to Data Out Valid	t_{AA}	0.1	-	0.9	0.05	-	0.9	μs
Time the bus must be free before a new transmission can start	t_{BUF}	1.2	-	-	0.5	-	-	μs
Start Hold Time	$t_{HD.STA}$	0.6	-	-	0.25	-	-	μs
Start Setup Time	$t_{SU.STA}$	0.6	-	-	0.25	-	-	μs
Data In Hold Time	$t_{HD.DAT}$	0	-	-	0	-	-	μs
Data In Setup Time	$t_{SU.DAT}$	100	-	-	100	-	-	ns
Inputs Rise Time(1)	t_R	-	-	0.3	-	-	0.3	μs
Inputs Fall Time(1)	t_F	-	-	300	-	-	300	ns
Stop Setup Time	$t_{SU.STO}$	0.6	-	-	0.25	-	-	μs
Data Out Hold Time	t_{DH}	50	-	-	50	-	-	ns
Write Cycle Time	t_{WR}	-	-	5	-	-	5	ms
5.0V, 25°C, Byte Mode	Endurance	1M	-	-	-	-	-	Write Cycles

Note

1. This parameter is characterized and is not 100% tested.
2. AC measurement conditions:
   RL (connects to V_{CC}): 1.3kΩ (2.5V, 5V), 10kΩ (1.7V)
   Input pulse voltages: 0.3 x V_{CC}, 0.5 x V_{CC}, 0.7 x V_{CC}
   Input rise and fall time: ≦50 ns
   Input and output timing reference voltages: 0.5 x V_{CC}
   The value of RL should be concerned according to the actual loading on the user's system.

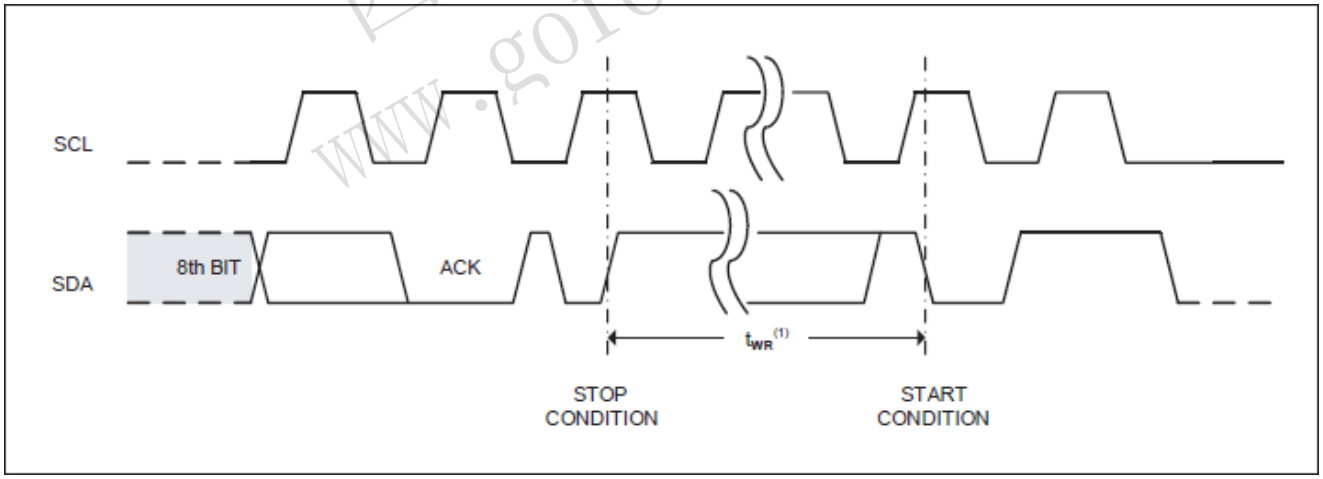
Bus Timing

Figure 10: SCL: Serial Clock, SDA: Serial Data I/O



Write Cycle Timing

Figure 11: SCL: Serial Clock, SDA: Serial Data I/O



Note

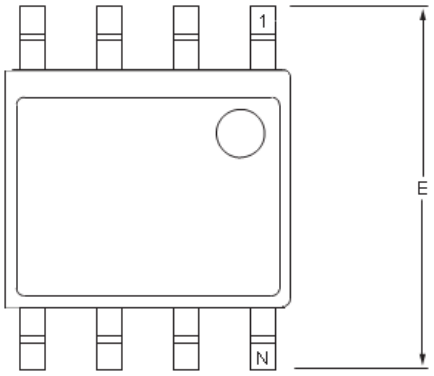
The write cycle time tWR is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.

Mechanical Dimensions

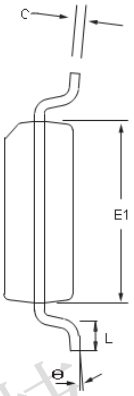
OUTLINE DRAWING SOP 8

Available package types：AX24C128A/256A

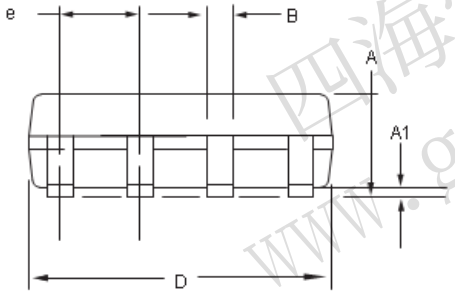
Top View



End View



Side View



COMMON DIMENSIONS
(Unit of Measure = mm)

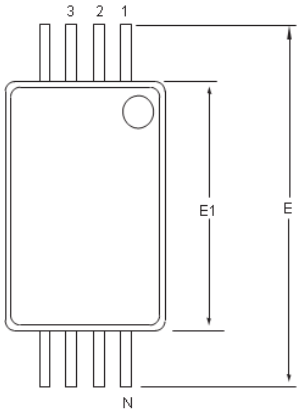
SYMBOL	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
b	0.31	0.51
C	0.17	0.25
D	4.70	5.10
E1	3.80	4.00
E	5.79	6.20
e	1.27 BSC	
L	0.40	1.27
θ	0°	8°

Mechanical Dimensions

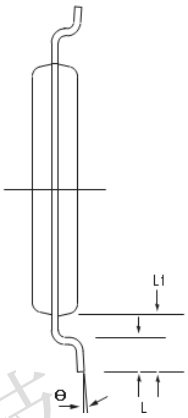
OUTLINE DRAWING TSSOP 8

Available package types：AX24C128A/256A

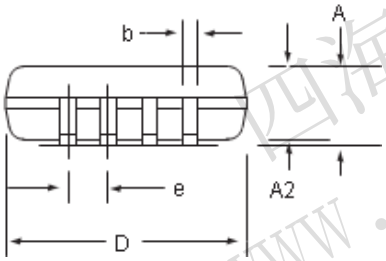
Top View



End View



Side View



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	MAX
D	2.80	3.20
E	6.20	6.60
E1	4.20	4.60
A	-	1.20
A2	0.80	1.15
b	0.19	0.30
e	0.65 BSC	
L	0.45	0.75
L1	1.00 BSC	
θ	0°	8°